EVENTS 2019
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In close cooperation with renowned experts and the responsible editorial offices of our well-known media brands, we organise around 50 national and international B2B congresses, seminars and workshops every year for a defined specialist audience.

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- Congresses, seminars, workshops
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- 8,000 participants per year
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Also before and after each event, our editorial offices report in print and online on the topics that are relevant for you.

Timeliness!
The constant expansion of our topics guarantees you the most current and relevant information.

Strong partners!
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## Our events of the year 2019 and 2020 at a glance

<table>
<thead>
<tr>
<th>Event</th>
<th>Date</th>
<th>Location</th>
<th>Page</th>
<th>Automation</th>
<th>Automotive</th>
</tr>
</thead>
<tbody>
<tr>
<td>Datacenter Symposium Cologne</td>
<td>May 15, 2019</td>
<td>Cologne</td>
<td>7</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Tech Forum Berlin</td>
<td>Jun 4, 2019</td>
<td>Berlin</td>
<td>6</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Tech Forum Stuttgart</td>
<td>Jul 2 - 3, 2019</td>
<td>Stuttgart</td>
<td>6</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Tech Forum Cologne</td>
<td>Sep 17 - 18, 2019</td>
<td>Cologne</td>
<td>6</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Cabling &amp; Datacenter Vienna</td>
<td>Nov 5, 2019</td>
<td>Vienna</td>
<td>6</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Tech Forum Munich</td>
<td>Feb 4 - 5, 2020</td>
<td>Munich</td>
<td>6</td>
<td></td>
<td></td>
</tr>
<tr>
<td>automatedDC</td>
<td>Apr 8 - 9, 2019</td>
<td>Mainz</td>
<td>8</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Smart Building Summit</td>
<td>May 2, 2019</td>
<td>Dresden</td>
<td>9</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Forum Wireless Automation</td>
<td>May 2, 2019</td>
<td>Dresden</td>
<td>10</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>User Forum 5G Measurement Technology</td>
<td>May 3, 2019</td>
<td>Dresden</td>
<td>11</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forum Artificial Intelligence</td>
<td>May 3, 2019</td>
<td>Dresden</td>
<td>12</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td></td>
<td>May 14, 2019</td>
<td>Stuttgart</td>
<td>11</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Blockchain Summit</td>
<td>May 8, 2019</td>
<td>Nuremberg</td>
<td>13</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>User Forum Lightweight Robotics &amp; Human Robot Collaboration</td>
<td>May 21, 2019</td>
<td>Munich</td>
<td>14</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>User Forum Passive Components</td>
<td>Jul 2 - 3, 2019</td>
<td>Munich</td>
<td>15</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>Forum Safety &amp; Security</td>
<td>Jul 8 - 10, 2019</td>
<td>Sindelfingen</td>
<td>16</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>User Day Battery &amp; Power</td>
<td>Jul 10 - 11, 2019</td>
<td>Munich</td>
<td>17</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Channel Conference</td>
<td>Sep 19, 2019</td>
<td>Fuerstenfeldbruck</td>
<td>18</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Oct 15, 2019</td>
<td>Cologne</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Electrical System Congress</td>
<td>Sep 26, 2019</td>
<td>Landshut</td>
<td>19</td>
<td></td>
<td>●</td>
</tr>
<tr>
<td>TSN/A Conference – Technology &amp; Applications</td>
<td>Oct 8 - 9, 2019</td>
<td>Bad Homburg</td>
<td>20</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Digital Workplace Forum</td>
<td>Oct 17, 2019</td>
<td>Fuerstenfeldbruck</td>
<td>21</td>
<td>●</td>
<td>●</td>
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<tr>
<td>Wireless Congress: Systems &amp; Applications</td>
<td>Oct 22 - 23, 2019</td>
<td>Munich</td>
<td>22</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>User Forum Power Semiconductors</td>
<td>Oct 19 - 20, 2019</td>
<td>Munich</td>
<td>23</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Conference Internet of Things – from sensor to cloud</td>
<td>Nov 20 - 21, 2019</td>
<td>Munich</td>
<td>24</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Automation 4.0 Summit</td>
<td>Nov 26 - 27, 2019</td>
<td>Fair Nuremberg</td>
<td>25</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>BatteryWorld</td>
<td>Jan 22 - 23, 2020</td>
<td>Munich</td>
<td>26</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Forum Power Architectures</td>
<td>Jan 22 - 23, 2020</td>
<td>Munich</td>
<td>27</td>
<td></td>
<td>●</td>
</tr>
<tr>
<td>Smarthouse Trend Day</td>
<td>Jan 27, 2020</td>
<td>Haar</td>
<td>28</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Automotive Ethernet Congress</td>
<td>Feb 12 - 13, 2020</td>
<td>Munich</td>
<td>29</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>embedded world Conference</td>
<td>Feb 25 - 27, 2020</td>
<td>Fair Nuremberg</td>
<td>30</td>
<td>●</td>
<td>●</td>
</tr>
<tr>
<td>embedded displays Conference</td>
<td>Feb 26 - 27, 2020</td>
<td>Fair Nuremberg</td>
<td>31</td>
<td>●</td>
<td></td>
</tr>
<tr>
<td>Event Date</td>
<td>Location</td>
<td>Page</td>
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<td>Berlin</td>
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<td>Jul 2 - 3, 2019</td>
<td>Stuttgart</td>
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<td>Sep 17 - 18, 2019</td>
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<td>7</td>
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<tr>
<td>Nov 5, 2019</td>
<td>Vienna</td>
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<td>Feb 4-5, 2020</td>
<td>Munich</td>
<td>6</td>
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<tr>
<td>Apr 8-9, 2019</td>
<td>Mainz</td>
<td>8</td>
<td></td>
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<td>May 2, 2019</td>
<td>Dresden</td>
<td>9</td>
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<td>15</td>
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<td>Jul 8 - 10, 2019</td>
<td>Sindelfingen</td>
<td>16</td>
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<td>Jul 10 - 11, 2019</td>
<td>Munich</td>
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<td>18</td>
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<td>Landshut</td>
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<td>Oct 8-9, 2019</td>
<td>Bad Homburg</td>
<td>20</td>
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<td>Oct 17, 2019</td>
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<td>21</td>
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<td></td>
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<tr>
<td>Oct 22-23, 2019</td>
<td>Munich</td>
<td>22</td>
<td></td>
<td></td>
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<td>Oct 19-20, 2019</td>
<td>Munich</td>
<td>23</td>
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<td>Nov 20-21, 2019</td>
<td>Munich</td>
<td>24</td>
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<td>Nov 26-27, 2019</td>
<td>Fair Nuremberg</td>
<td>25</td>
<td></td>
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<td></td>
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<td>Jan 22-23, 2020</td>
<td>Munich</td>
<td>26</td>
<td></td>
<td></td>
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<tr>
<td>Jan 22-23, 2020</td>
<td>Munich</td>
<td>27</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Jan 27, 2020</td>
<td>Haar</td>
<td>28</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Subject to change. Current status can be viewed at www.weka-fachmedien.de
The LANline Tech forums take place in a proven manner at various locations in Germany, Austria and Switzerland and are attended by over 650 people. As established events, they offer an excellent opportunity to find out about all new developments in technology, standardization and products in technology or product presentations. In addition, there is sufficient time for intensive networking with top-class representatives of the manufacturers as well as with colleagues from the planning, implementation and operation of the cabling infrastructure.

**Dates:**
- Tech Forum, Berlin  
  Jun 4, 2019
- Tech Forum, Stuttgart  
  Jul 2 – 3, 2019
- Tech Forum, Cologne  
  Sep 17 – 18, 2019
- Cabling & Datacenter, Vienna  
  Nov 5, 2019
- Tech Forum, Munich  
  Feb 4 – 5, 2020

**Website:**
www.lanline.de/events/tech-forum/

**Top issues:**
- The new version of EN 50173
- Update of standardization and technology of parallel optics
- What categories 8.1 and 8.2 achieve
- Single-pair ethernet in practice
- 40GBase-T and 25GBase-T
- Measurement technology and certification of the new ethernet classes

**Target group:**
Network administrators, IT administrators, installers, network managers, data center managers, planners, infrastructure experts

**Industries:**
Datacenter – Digitization – ICT
Communication – Network Infrastructure
Power Supply – Cabling
Own Datacenter in Interaction with Cloud, Hosting & Colocation

Data centers are the heart of today’s businesses and must deliver high performance as well as meet ever-increasing energy and cost efficiency requirements. To achieve this, those responsible for both the procurement of infrastructure and its operation need sound specialist knowledge. The Datacenter Symposium brings data center specialists and managers up to date with the latest know-how - independent, highly informative and particularly practical. Experts, industry insiders and data center operators come together here. High-class lectures and workshops will serve this purpose.

Top issues:
- Energy efficiency in data centers
- Effects of EN 50600 on planning and operation
- DCIM, Monitoring, AIM
- Cooling, free cooling, adiabatic
- Fire protection, alerting, physical security
- Modern power supply technology

Target group:
Computer center specialists and responsible persons

Industries:
Datacenter – Digitization – ICT
Communication – Air Conditioning – Cooling – Monitoring – Safety & Security
Power Supply

Dates:
- Datacenter Symposium, Hanau: February 27 – 28, 2019
- Datacenter Symposium, Cologne: May 15, 2019
- Datacenter Symposium, Stuttgart: October 15 – 16, 2019
- Cabling & Datacenter, Vienna: November 5, 2019

Website:
www.lanline.de/events/datacenter-symposium

Host:
The Datacenter of Tomorrow

Experience the datacenter of tomorrow. The new event format from funkschau and Grass Events provides IT managers with in-depth insights into the key technologies and strategies that will determine data center operations in the future. The one-day event with evening program bundles lectures, workshops, exhibitions and networking and offers participants a unique information and communication platform.

Date:
April 8 – 9, 2019 in Mainz

Website:
www.automated-dc.de

Top issues:
• Monitoring
• Machine learning
• Robotics
• AI
• Digital twin
• Datacenter management
• Measurement, analysis and control

Target group:
IT managers, data center managers, NOC employees, network administrators and planners, energy managers, controllers, organizers, security managers, infrastructure managers, resellers, consultants, data center planners, etc.

Industries:
Automation – Datacenter
Digitization – ICT

Hosts:
“The Place to Be” for all Smart Home & Building Enthusiasts

Smart home and building technologies are constantly opening up new areas of application. Smart Buildings form the core of future Smart Cities infrastructures. From technology to use cases, the latest business models, current market analyses to the presentation of pioneers in urban networking and digitisation, the Summit offers a comprehensive survey of smart building technology, market and prospects.

Date:
May 2, 2019 in Dresden

Website:
www.smart-building-summit.de

Top issues:
• Chips, controllers, sensors and embedded computers for the smart infrastructure
• Energy efficiency, metering and management
• Lighting
• Building security and monitoring
• Comfort and entertainment
• New services and business models
• Integration of renewable energies into the smart grid
• Integration of smart homes and smart buildings into smart cities

Target group:
Manufacturers and developers of smart building technology, automation and lighting, housing and property management, planning offices, architects and building owners, energy consumers, service providers and efficiency managers

Industries:
Automation – Digitization
Embedded – ICT – Communication
Safety & Security – Power Supply

Host:
SmarterWorld
Without wireless there is no IoT and no industry 4.0. Modern communication technology without cables - whether by radio or light - is a decisive factor for industrial production and globally networked value chains. To the current challenges: Reliability and low latency (URLLC), management of a huge number of end devices (mMTC) as well as high data rates (eMBB) are being worked on worldwide - not only in the context of 5G mobile radio.

**Top issues:**
- LPWAN (Low Power Wide Area Network)
- mMTC (massive Machine Type Communications)
- URLLC (Ultra-Reliable Low-Lateny Communication)
- WSN (Wireless Sensor Network)
- IIoT (Industrial Internet of Things)
- Industry 4.0

**Target group:**
Professional users, system developers and integrators of wireless systems in the industries: Industry, automotive engineering and suppliers, medical technology, energy technology, logistics

**Industries:**
Automation – Automotive
Datacenter – Digitization – Embedded
Industrial Electronics – ICT – Communication – Safety & Security

__Date:__
May 2, 2019 in Dresden

__Website:__
www.forum-wireless-automation.de
5G - Mastering Metrological Challenges with Confidence

5G is one of the biggest trends of this time. Beyond the mobile phone industry, many industries are waiting for the implementation of the new communication standard. At the 1st 5G Measurement Technology User Forum, participants will learn about the measurement challenges posed by 5G and how they can be overcome. The leading metrology experts will provide practical assistance.

**Date:**
May 2, 2019 in Dresden

**Website:**
www.anwenderforum-5g.de

**Top issues:**
- Prototyping
- Device test
- Infrastructure test
- Deployment
- Testing service
- Approval scenarios

**Target group:**
Product and system developers, hardware and software specialists, test engineers, quality testing and certification engineers

**Industries:**
Industrial Electronics – ICT
Communication

Host:
Markt&Technik
Artificial intelligence has become the focus of many technical developments. AI, machine learning and neural networks are key technologies that enable systems to react autonomously and make decisions based on external influences. The Artificial Intelligence Forum will examine the rapid developments in hardware and software.

Top issues:
- AI in embedded-systems: Hardware and software-components for the design of AI-systems
- AI in automotive and telematics: Autonomous driving, traffic control, Safety & Security
- AI in the factory: Machine learning, predictive maintenance, optimization of working environment and production

Target group:
Product manager as well as hardware and software developer. Users, for example, in the field of automation technology or in machine and plant construction. Embedded system designers of self-learning systems.

Industries:
Automotive – Digitization – Embedded ICT

Dates:
May 2, 2019 in Dresden
Mai 14, 2019 in Stuttgart

Website:
www.forum-ki.eu
www.forum-ai.eu
Blockchain Technology in Application for the Industry

The Blockchain Summit, organized by Markt&Technik and NürnbergMesse, focuses on the technical requirements and proven business models as well as challenges and hurdles for the use of blockchain in industry. If you are interested in how you can profitably implement blockchain technology in your company, what you need for it and what possibilities there are for you, then the Blockchain Summit 2019 is the right place for you.

**Top issues:**
- Use cases and business models from industry, production, logistics and energy
- Blockchain techniques and platforms
- Blockchain vs. distributed ledger
- Blockchain-as-a-Service- and premise models
- Blockchain vs. "classic" distributed applications
- Legal requirements
- Standardization
- Blockchain and digital twins

**Target group:**
Designers and users of Blockchain systems

**Industries:**
Automation – Automotive – Digitization
Embedded – Industrial-Electronikcs – ICT

**Date:**
May 8, 2019 in Nuremberg

**Website:**
www.blockchain-summit.de
Human Robot Collaboration

Lightweight industrial robots from various manufacturers are about to conquer the factory halls. Most of the one- or two-armed helpers can work hand in hand with human colleagues as "colleague robots", so they are collaborative and are therefore also called "cobots". It is becoming apparent, however, that many cobot applications will continue to exist in the future without human-robot collaboration. In most cases, cobots are currently used for flexible and cost-effective automation - without direct cooperation with humans. The User Forum Lightweight Robotics & Human Robot Collaboration aims to clarify this issue.

Top issues:
- Collaborative and non-collaborative applications
- Concrete design of the human-robot collaboration
- Implementation of lightweight robot applications in the company
- Safety certification steps
- Stationary and mobile lightweight robots

Target group:
Decision-makers from management, logistics, manufacturing (organisation), application engineering, project management, development and purchasing

Industries:
Automation – Automotive – Digitization
Industrial Electronics

Date:
May 21, 2019 in Munich

Website:
www.leichtbaurobotik-mrkde
Passive for Professionals

The user forum is intended to provide circuit developers and technical purchasers with the most important basics on passive components so that they can become safer and more familiar when dealing with capacitors and the like. The event will mainly be held in German. In terms of application technology, it is primarily dedicated to the use of passive components in the fields of industrial electronics, medical technology, renewable energies and automotive. At the accompanying trade exhibition, manufacturers and service providers present their latest products and interesting applications and are available for intensive discussions.

**Top issues:**
- Types of resistors, capacitors and inductors
- Material and design characteristics (frequency, temperature and voltage dependence)
- Electromagnetic compatibility
- Interaction with active components and ICs
- Standards
- Case studies
- Optimization of the supply chain (allocation)

**Target group:**
Electronics developers, system developers and technical buyers from the industrial electronics, embedded systems and automotive sectors

**Industries:**
Automation – Automotive
Renewable Energies – Industrial Electronics
Medical Engineering

**Date:**
July 2 – 3, 2019 in Munich

**Website:**
www.passive-anwenderforum.de

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**Hosts:**
Markt&Technik
Design & Elektronik
Industrial – Automotive – Medical Technology

Systems that directly affect humans must be functionally safe. The fact that these systems often also have to be secure is made clear by the hacker attacks that are becoming more and more common. Which problems and solutions these aspects, and, in addition, the interaction of both of them, bring with themselves, is discussed in the Forum Safety & Security.

Top issues:
- Basics
- Hardware and software tools
- Automotive
- Industry
- Medicine

Target group:
Hardware and software developers, integrators, manufacturers, designers, developers and users, functional safety engineers/managers, security experts, auditors, certification managers, test managers, test engineers, quality assurance experts

Industries:
Automation – Automotive
Digitization – Embedded
Safety & Security

Termin:
8. – 10. Juli 2019 in Sindelfingen

Website:
www.safety-security-forum.de
Self-Designed Power Supply

Among other things, electronics developers have the task of designing a power supply for the system to be developed - whether the application is powered by mains or battery. Since the power sector is often not one of the core competencies of these developers, they do not usually design the power supply solution themselves, but purchase it. The Battery & Power User Day is intended to convey the most important basics on power supply units and DC/DC converters as well as on batteries, rechargeable batteries and charging concepts.

Date:
July 10 – 11, 2019 in Munich

Website:
www.anwendertag-batterie-strom.de

Top issues:
- Power supply architectures
- Electrical and thermal characteristics
- Environmental factors
- Electromagnetic compatibility
- Safety & Security
- Customer-specific vs. standard solution
- Basics and properties of the different battery systems
- Loading methods
- Battery management
- Cell production
- Design and construction of battery packs

Target group:
Electronics developers and technical buyers from the application areas industry, medicine, automotive and smart house (building technology)

Industries
Automotive – Embedded – Industrial Electronics – Power Supply

Hosts:
Never before has the range of IT deployments been as wide as it is today. Multicloud and hybrid IT offer system houses and MSPs a wide range of possible ICT solutions. Managed services are in high demand. Services including hardware in the rental model are very well received by system house customers. What is important - in terms of technology, sales and organization in the MSP model of the future? And what role does the classic project business, „sheet metal“ and software still play? System house bosses report from their practical experience, manufacturers and distributors show proven IT solutions at the CRN Channel Conference - networking included.

Dates:
Sep 19, 2019 in Fuerstenfeldbruck
Oct 15, 2019 in Cologne

Website:
www.channel-konferenz.de

Top issues:
• Business cloud
• Managed services
• Security
• Storage
• Network management
• Internet of things
• Big data & analytics

Target group:
Exclusive target group of up to 100 participants (system houses/IT service providers, MSPs/hosters, system integrators, IT consultants, value added distributors)

Industry:
ICT
No Matter How the Vehicle Changes - the On-board Network Remains

More than 90 percent of vehicle innovations today are determined by electronics. These electronic functions require a powerful backbone that supplies them with power and networks them for data exchange. This must keep pace with current developments, such as the increased electrification of the powertrain, the increasing internal and external networking and the trend towards autonomous driving. The Wiring Systems Congress will cover all relevant aspects of partitioning current E/E architectures and the implementation of wiring systems.

Top issues:
- Development and simulation of vehicle electrical systems
- E/E architectures
- Cable systems for energy and information transmission and cable harness production
- Multi-voltage vehicle electrical systems in electric and hybrid vehicles
- Integration of electronic development processes into overall vehicle development
- Requirements engineering
- Continuous digitization
- Networking concepts in the vehicle

Target group:
Wiring system developers and engineers at OEMs and Tier N suppliers, developers of automotive cables and connectors, system integrators and development managers at OEMs and Tier N suppliers, scientists from research and teaching in the automotive field

Industries:
Automotive – Communication
Power Supply

Date:
September 26, 2019 in Landshut

Website:
www.bordnetz-kongress.de
Industrial – Automotive – Audio/Video

Time Sensitive Networking - TSN - provides standard ethernet with a standardized real-time extension. TSN will have a far-reaching influence, especially on the industrial, automotive and audio/video/consumer segments. The TSN/A Conference will highlight the technological aspects of the standard as well as application-relevant topics in the three user industries.

Date: October 8 – 9, 2019 in Bad Homburg
Website: www.tsnacconference.de

Top issues:
- TSN roadmaps of semiconductor manufacturers
- Plans and implementations of the automators in terms of TSN
- Challenges/opportunities for machine builders
- Migration strategies of the fieldbus providers
- Requirements/plans of automobile manufacturers
- TSN activities in the audio/video/consumer world

Target group:
Developers and suppliers of automation components and devices, mechanical engineers, automotive suppliers and manufacturers, manufacturers from the audio/video/consumer world

Industries:
Digitization – ICT – Communication
Safety & Security

Hosts:

In cooperation with:
Strategies for the Workplace of the Future

The Digital Workplace Forum is the information and communication platform for technologies and strategies relating to the workplace of the future. The one-day event bundles all topics of the digital and networked working world in editorially selected lectures, practice-oriented workshops and a wide-ranging trade exhibition and stands for an exciting exchange between innovation drivers, technology experts and users from the most diverse industries.

Date:
October 17, 2019 in Fuerstenfeldbruck

Website:
www.digital-workplace-forum.de

Top issues:
• Digital workplace strategies
• Unified communications & collaboration
• Private, hybrid- and public cloud models
• Mobile work
• Data protection and compliance
• Safety concepts
• Change management and employee development
• Big data, VR, machine learning, AI: What will the future bring?

Target group:
CEOs, CIOs, CDOs, CTOs, IT managers, IT and TC administrators, system houses, value added resellers

Industries:
ICT user companies from all-industries
Next Generation Wireless Networks

It is fascinating to be able to retrieve information at any time and any place. The associated mobile use of the Internet has brought a boom to mobile network operators. This success story should now become a model for more and more professional applications, in industry, in the automobile, in medical technology, etc. The Internet of Things and Industry 4.0 are only two drivers of the current development. Low costs in the development and operation of wireless applications make wireless technologies economically interesting for mass applications.

Date:
October 22 – 23, 2019 in Munich

Website:
www.wireless-congress.com

Top issues:
- Mobile radio technologies and M2M
- Low-power radio technologies
- Radio networks and radio sensor networks
- Reliability, security and protection in wireless networks
- Energy self-sufficient radio nodes and energy harvesting
- Radio communication technologies with low latency - for automation technology, use in automobiles, tactile Internet
- Standardisation, interoperability and conformity
- EMV and compliance

Target group:
Developers of radio systems and terminals with radio interface, software developers for radio applications, system developers and product managers, system integrators and professional users, suppliers of wireless systems and components, QM and compliance managers, product designers, scientific staff

Industries:
Automotive – Automation
Digitization – Embedded – ICT
Communication – Safety & Security
Intensive Training on MOSFET, IGBT & Co.

Power semiconductors are core components of any power supply, DC/DC converter or inverter. However, the market for MOSFET, IGBT & Co. is almost unmanageable in terms of individual favorites. At the Power Semiconductors User Forum, developers and technical purchasers receive practical assistance on how to move more safely in this field and find the best solution for their respective project.

Top issues:
- Types of power semiconductors (MOSFET, IGBT, modules, SiC, GaN)
- Internal structure of power semiconductors
- Housing types
- Failure mechanisms, reliability and ageing
- Losses and heat dissipation
- Wiring
- Electromagnetic compatibility
- Interaction with other components

Date:
November 19 – 20, 2019 in Munich
Website:
www.leistungshalbleiter-anwenderforum.de

Target group:
Electronics developers and technical buyers from the industrial electronics, embedded systems and automotive sectors

Industries:
Automotive – Digitization – Embedded Industrial Electronics – Communication Safety & Security

Hosts:
Everything about IoT Applications and Platforms

The main topics of this event are hardware, device-related software, testing and test strategies, connectivity, middleware in gateways and data collectors, IoT platforms and the necessary tools. The conference covers the entire spectrum from Little Data and Smart Data to the consolidation and pre-processing of these data and the interface to Big Data.

Date:
November 20 – 21, 2019 in Munich

Website:
www.iot-konferenz.de

Top-issues:
• Aggregate, analyze and securely transfer data
• Software & tools for IoT applications
• Gateways
• Alliances & Ecosystems
• IoT platforms, frameworks and services

Target group:
Hardware developers, software developers, system designers, suppliers along the value chain, scientific and research institutions, technical buyers, practical users

Industries:
Digitization – Embedded – ICT

Hosts:
Parallel to SPS

Accompanying the SPS - Smart Production Solutions - the editorial offices of Computer&AUTOMATION, Elektronik and Markt&Technik are organising the Automation 4.0 Summit in Nuremberg for the fifth time.

Date:
November 26 – 27, 2019
Exhibition Centre Nuremberg

Website:
www.automation-40.de

Top issues:
• Edge computing in the industry – possibilities and limits
• TSN and OPC UA in the industry
• IoT platforms in the industry
• Sensor technology for Industry 4.0

Target group:
Specialists and executives from automation technology, manufacturing industry, asset engineering and mechanical engineering

Industries:
Automation – Automotive – Embedded

Takes place in parallel to SPS – Smart Production Solutions!
BatteryWorld revolves around all challenges around the entire value and supply chain of rechargeable batteries. We want to cover the entire spectrum from supply security of essential raw materials such as lithium, cell chemistry, cells and their production, the engineering of battery packs as well as the diverse applications to Second Life and recycling.

**Technologies, Solutions, Smart Concepts**

**Top issues:**
- Electromobility
- Home storage
- Portable electronics

**Target group:**
Manufacturers, users, energy suppliers, industry, commerce, battery consultants, mobility providers, start-ups, university employees

**Industries:**
Automotive – Industrial Electronics
Power Supply

**Date:**
January 22 – 23, 2020 in Munich

**Website:**
www.battery-world.de
Products, Concepts and Solutions

Among other things, electronics developers have the task of designing a power supply for the system to be developed. Since the power sector is often not one of their core competencies, the power supply solution is not developed in-house but purchased. The event is intended to convey the most important basics about power supplies and DC/DC converters so that electronics developers and technical buyers from the application areas of industry, medicine and smart house (building services engineering) can make a qualified preselection on the basis of the data sheet of a power supply and ask the power supply manufacturer the appropriate further questions.

Date:
January 22 – 23, 2020 in Munich

Website:
www.forum-power-architectures.de

Top issues:
• Architectures (central or distributed power supply)
• Static and dynamic characteristic values
• Thermal characteristic values (derating) and concepts
• Environmental influences due to temperature, climate, shock and vibration
• Special features such as “Extra Power” and “Selective Fuse Breaking”
• Galvanic isolation and amplified galvanic isolation
• Electromagnetic compatibility

Target group:
Electronics developers and technical buyers from industrial electronics, embedded systems

Industries:
Industrial-Electronics – Embedded Power Supply

Hosts:

Partner:
The Smart Building of the Future

"The Smart Building of the Future" is the focus of the 3rd Trend Day of elektrobörse smarthouse. Voice assistants, cloud services, etc. - the development of smart building technology is progressing rapidly. At the smarthouse Trend Day, electricians can find out about the latest trends and products and make new contacts.

Date:
January 27, 2020 in Haar

Website:
www.smarthouse-trend-tag.de

Top issue:
Smart building technology

Target group:
Electrical installers, installers, electrical planners, system integrators

Industries:
Building Technology – Building Automation
Smart Home – Smart City
Safety & Security
Powerful Network for the Car of Tomorrow

Autonomous driving is not possible without a strong vehicle network such as Automotive Ethernet. The Automotive Ethernet Congress, taking place for the sixth time this year, provides a comprehensive overview of the wide range of technical innovations. Practice-oriented contributions will provide well-founded specialist knowledge for all those who want to tap and exploit the full potential of Automotive Ethernet. Last but not least, participants in workshops will have the opportunity to discuss and possibly solve a problem in small groups.

**Date:**
February 12 – 13, 2020 in Munich

**Website:**
www.automotive-ethernet-congress.de

**Top issues:**
- Basic knowledge for ethernet users
- The integration of ethernet into the overall network
- Physical layer
- Interoperability tests
- AVB and TSN in practice
- Use cases: New applications for ethernet

**Target group:**
Engineers and system architects of network technologies and communication, software engineers, ECU testers, decision makers at OEMs and Tier 1s

**Industries:**
Automotive – Embedded – Communication

**Conference language is English**

Host:

In cooperation with:
The embedded world Conference is the largest event of its kind worldwide. The conference is an essential part of the dynamic environment of the embedded world, which over the years has developed into an international meeting place for the professional embedded developer community. Here, experienced developers come together to share their knowledge and help others turn their ideas and inventions into real products.

**Meeting point for the Community**

**Date:**
February 25 – 27, 2020
Exhibition Centre Nuremberg

**Website:**
www.embedded-world.eu

**Top issues:**
- Internet of things – platforms & applications
- Connected systems
- Embedded OS
- Safety & Security
- Hardware engineering
- Software & systems engineering
- Embedded vision
- Autonomous & intelligent systems
- Embedded GUI & HMI
- System-on-Chip (SoC)

**Target group:**
Hardware/software developers, system designers, suppliers and users of test systems, scientific and research institutions, technical buyers, practical users

**Industries:**
Automation – Automotive – Digitization
Embedded – ICT – Communication
Safety & Security
The Most Important European B2B Platform for Display Technologies

The 34th electronic displays Conference (edC) serves to present innovative ideas, approaches, developments and research projects in the field of today’s and tomorrow’s display business. The conference enables the exchange of the latest advances and information between engineers, experts, users, researchers, dealers, consultants and manufacturers working in the field of modern electronic displays and their applications. edC 2018 was a great success with more than 500 display experts and more than 40 presentations as well as seven state-of-the-art keynotes.

Top issues:
- Touch technologies & integration
- Display measurements
- Future automotive displays & optimizations
- Displays systems & HMI
- Automotive functional safety & interfaces
- Display optimizations by functional films
- Automotive HUDs
- HDR displays & evaluation
- Micro-OLEDs
- Automotive displays: Evaluation & surfaces
- E-Signage displays
- New technologies & applications

Target group:
Engineers, users, researchers, traders, consultants, manufacturers

Industries:
Automotive – Displays – Embedded – ICT

Date:
February 26 – 27, 2020
Exhibition Centre Nuremberg

Website:
www.electronic-displays.de
Seminars & Workshops

With our proven seminar series "Training for Professionals" we offer a quick introduction to new techniques. Here, competent and experienced trainers impart the necessary specialist knowledge in intensive seminars, usually lasting several days, so that the participants can use the learned techniques directly and successfully in their own projects. Practical examples, often also the possibility of trying out what has been learned directly in the seminar, and the opportunity to ask the experts questions are essential success factors of this series of events.

The current topics and dates can be found here:
www.training-for-professionals.de

If you are interested we look forward to hearing from you:
www.training-for-professionals.de/kontakt/kontaktformular

Top issues:
We offer further seminars among others on the following topics.
• Implementation of the EU Data Protection Basic Regulation
• IoT Innovation Development
• Secure Product Design
• Continuous Integration
• Legacy Code
• Arduino
• Embedded Linux
• EMV
• Yocto
• Intely
Training and Practice for Infrastructure and IT

The LANline Workshops are designed by recognized experts from the field and deal with important topics around IP-based networks. They are therefore aimed at practitioners who want to implement what they have learned directly, but also at planners/investors who are responsible for product and technology selection or operation.

The current topics and dates can be found here: www.lanline.de/events/lanline-workshops

Top issues:
- Certification course WLAN
- EMV
- Future-oriented cabling concepts
- Fiber optic transmission technology
- Workshops on new EN standards
Would you like to bring your products and solutions closer to your target group in a relaxed setting? Do you attach importance to your external image in front of potential customers?

Present your company to the participants of our events at the accompanying trade exhibition. Show your products and solutions to a competent and interested audience.

- 100% professional audience
- Tailor-made exhibitor- and sponsoring packages
- 213 Exhibitors & Sponsors in 2018
- Cross-media communication

Excerpt from our exhibitors and sponsors 2018:
<table>
<thead>
<tr>
<th>Valuable contacts!</th>
<th>No coverage waste!</th>
<th>Show competence!</th>
</tr>
</thead>
<tbody>
<tr>
<td>Meet your potential customers on site</td>
<td>The clear focus of the event ensures that only the audience who is interested in the topic is present.</td>
<td>Demonstrate your products and solutions</td>
</tr>
</tbody>
</table>

<table>
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<tr>
<th>Cross-media communication!</th>
<th>Personal address!</th>
<th>Strong corporate image!</th>
</tr>
</thead>
<tbody>
<tr>
<td>From Call for Papers to post-event reporting: We accompany every event around the clock - in print and online.</td>
<td>Meet participants and speakers in a relaxed atmosphere</td>
<td>Deepen the awareness level of your company</td>
</tr>
</tbody>
</table>

If you have any questions about Sponsoring & Exhibition, please do not hesitate to contact us:
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Sales Manager Events
Phone: +49 (0)89 / 255 56 1393
E-mail: cprell@weka-fachmedien.de